

INTERNATIONAL STANDARD

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**Field device integration (FDI®) –
Part 3: Server**

**Intégration des appareils de terrain (FDI®) –
Partie 3: Serveur**



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Part 3: Server**

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INTERNATIONAL
ELECTROTECHNICAL
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ICS 25.040.40; 35.100.05

ISBN 978-2-8322-6446-1

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CONTENTS

FOREWORD.....	5
1 Scope.....	7
2 Normative references	7
3 Terms, definitions, abbreviated terms and acronyms	8
3.1 Terms and definitions.....	8
3.2 Abbreviated terms and acronyms	8
3.3 Conventions.....	9
4 Overview	9
5 Information Model.....	9
5.1 General.....	9
5.2 Online/Offline.....	10
5.2.1 Overview	10
5.2.2 Transfer to device.....	10
5.2.3 Transfer from device.....	11
5.2.4 Interactive Transfer to device	11
5.3 Access privileges	11
5.4 Private Parameters	11
5.5 Locking.....	12
5.6 EditContext.....	13
5.6.1 Concept and usage model	13
5.6.2 Services	14
5.6.3 NodeIds.....	14
5.6.4 Reading.....	14
5.6.5 Writing.....	15
5.6.6 Writing dominant and dependent Variables.....	15
5.6.7 Actions (EDD METHODS).....	16
5.6.8 UIDs	16
5.6.9 Synchronization	17
5.7 Reading	17
5.7.1 General	17
5.7.2 Reading offline variables	18
5.7.3 Reading online variables	18
5.8 Writing	19
5.8.1 General	19
5.8.2 Write offline variables	20
5.8.3 Writing online variables	21
5.8.4 Writing to an EditContext	22
5.9 Subscription.....	23
5.9.1 General	23
5.9.2 Subscription of offline variables	24
5.9.3 Subscription of online variables	25
5.10 Device topology	26
5.10.1 General	26
5.10.2 Connection Points	26
5.10.3 Topology management	27
5.10.4 Topology scanning.....	30
5.10.5 Use of SCAN function.....	31

5.10.6	Validation of defined topology.....	31
5.11	User Interface Elements.....	32
5.11.1	User Interface Descriptions.....	32
5.11.2	User Interface Plug-ins.....	33
5.12	Actions.....	33
5.12.1	FDI® Server – FDI® Client interaction.....	33
5.12.2	Action state machine.....	36
5.12.3	Actions Proxies.....	37
5.12.4	INTERACTIVE_TRANSFER_TO_DEVICE Action.....	38
5.12.5	Actions, EDD Actions and Actions Proxies.....	39
6	OPC UA services.....	40
6.1	OPC UA profiles.....	40
6.2	Service error information.....	40
6.2.1	Overview.....	40
6.2.2	OPC UA services and their response.....	40
6.2.3	Mappings of EDDL response codes to OPC UA service response.....	41
6.3	Parameter value update during write service request.....	42
6.4	Localization.....	42
6.5	Audit events.....	42
7	Communication.....	42
7.1	Notation.....	42
7.2	General.....	43
7.2.1	Concepts.....	43
7.2.2	Terms.....	45
7.3	Communication Service processing.....	46
7.3.1	Communication Service invocation.....	46
7.3.2	Analyze communication path.....	46
7.3.3	Manage communication relations.....	47
7.3.4	Communication service request mapping.....	47
7.3.5	Communication service request propagation.....	48
7.3.6	Communication error handling.....	49
7.4	FDI® Communication Server specific handling.....	49
7.4.1	Discovery.....	49
7.4.2	Information Model synchronization.....	50
8	Parallel Execution within the FDI® Server.....	50
8.1	Motivation.....	50
8.2	Internal structure of the EDD interpreter.....	51
8.3	Rules for running an EDD entity.....	51
Annex A (informative)	FDI® Server functional structure.....	53
A.1	FDI® functional elements.....	53
A.2	FDI® Server extension.....	54
Annex B (informative)	Access privileges and user roles.....	56
B.1	User roles and usage case.....	56
B.2	Private data usage.....	57
Annex C (informative)	Parallel execution within the FDI® Server – Examples.....	58
C.1	Simple example for a synchronous execution.....	58
C.2	Example for a concurrent execution.....	58
C.3	Deadlock detection in concurrent execution.....	60

Annex D (informative) Read-Only mode for UID Views.....	61
D.1 Definition	61
Figure 1 – FDI® architecture diagram	7
Figure 2 – Locking services	12
Figure 3 – EditContext models	13
Figure 4 – Online EditContext state diagram for dominant and dependent Variables	15
Figure 5 – Offline EditContext state diagram for dominant and dependent Variables	16
Figure 6 – EditContext for EDD Methods.....	16
Figure 7 – Offline variable read.....	18
Figure 8 – Online variable read.....	19
Figure 9 – Offline variable write immediate	20
Figure 10 – Online variable write immediate	21
Figure 11 – Write with EditContext.....	23
Figure 12 – Offline variable subscription	24
Figure 13 – Online variable subscription	25
Figure 14 – Topology with Network objects (non-normative)	26
Figure 15 – Add Device to topology	28
Figure 16 – Remove Device from topology.....	29
Figure 17 – Scan topology	30
Figure 18 – Action execution.....	35
Figure 19 – Action state machine	36
Figure 20 – System communication integration example	43
Figure 21 – FDI® Communication Server integration example	44
Figure 22 – Gateway integration example	45
Figure 23 – Message propagation example scenario.....	48
Figure A.1 – Functional components of an FDI® Server.....	53
Figure A.2 – FDI® Server extensions.....	55
Figure B.1 – User roles and access privileges.....	56
Figure C.1 – Synchronous execution of two triggers.....	58
Figure C.2 – Concurrent execution of two triggers (step1).....	58
Figure C.3 – Concurrent execution of two triggers (step 2).....	59
Figure C.4 – Concurrent execution of two triggers (step 3).....	59
Figure C.5 – Concurrent execution of two triggers (step 4).....	59
Figure C.6 – Concurrent execution of two triggers.....	60
Table 1 – Action states	36
Table 2 – Action state transitions	37
Table 3 – EDD Action types and the EDD constructs that use them	39
Table 4 – OPC UA severity bits and EDDL response codes TYPE	41

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IEC 62769-3 has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process measurement, control and automation. It is an International Standard.

This third edition cancels and replaces the second edition published in 2021. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) added interactive transfer to device.

The text of this International Standard is based on the following documents:

Draft	Report on voting
65E/856/CDV	65E/913/RVC

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

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FIELD DEVICE INTEGRATION (FDI®) –

Part 3: Server

1 Scope

This part of IEC 62769 specifies the FDI®¹ Server. The overall FDI® architecture is illustrated in Figure 1. The architectural components that are within the scope of this document have been highlighted in this figure. Annex A provides a functional description of the FDI® Server.

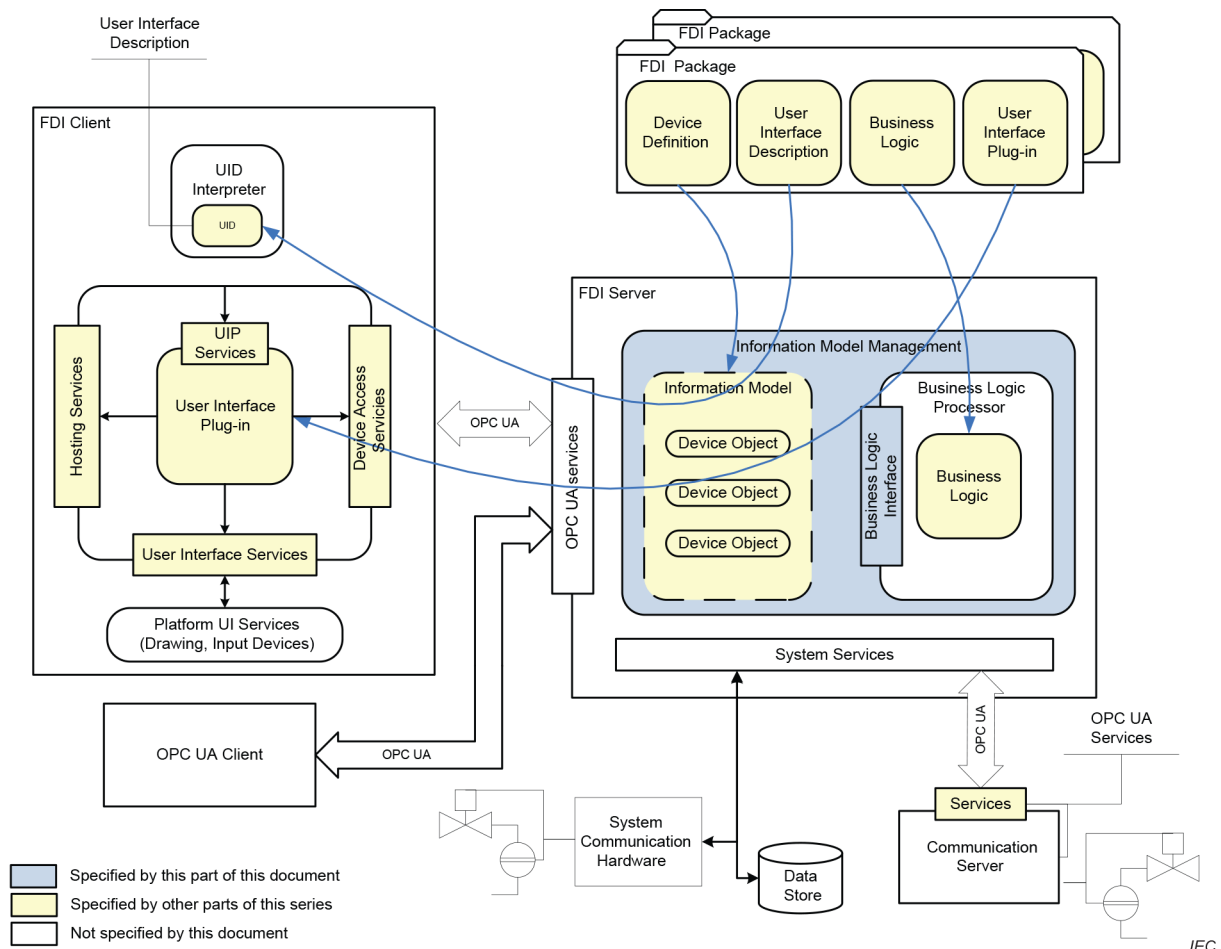


Figure 1 – FDI® architecture diagram

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